



MMBD4448HT /HTA /HTC /HTS

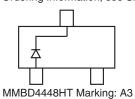
SURFACE MOUNT FAST SWITCHING DIODE

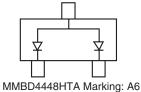
Features

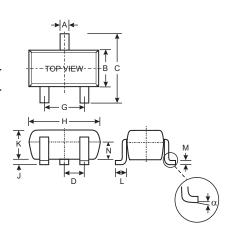
- Ultra-Small Surface Mount Package
- Fast Switching Speed
- For General Purpose Switching Applications
- High Conductance
- Lead Free/RoHS Compliant (Note 3)

Mechanical Data

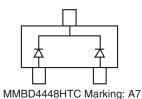
- Case: SOT-523
- Case Material: Molded Plastic. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020C
- Terminals: Solderable per MIL-STD-202, Method 208
- Lead Free Plating (Matte Tin Finish annealed over Alloy 42 leadframe).
- Polarity: See Diagrams Below
- Marking: See Diagrams Below & Page 3
- Weight: 0.002 grams (approx.)
- Ordering Information, see Sheet 2

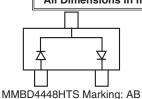






SOT-523								
Dim	Min	Max	Тур					
Α	0.15	0.30	0.22					
В	0.75	0.85	0.80					
С	1.45	1.75	1.60					
D	_	_	0.50					
G	0.90	1.10	1.00					
Н	1.50	1.70	1.60					
J	0.00	0.10	0.05					
K	0.60	0.80	0.75					
L	0.10	0.30	0.22					
М	0.10	0.20	0.12					
N	0.45	0.65	0.50					
α	0°	8°	_					
All D	All Dimensions in mm							





Maximum Ratings @ T_A = 25°C unless otherwise specified

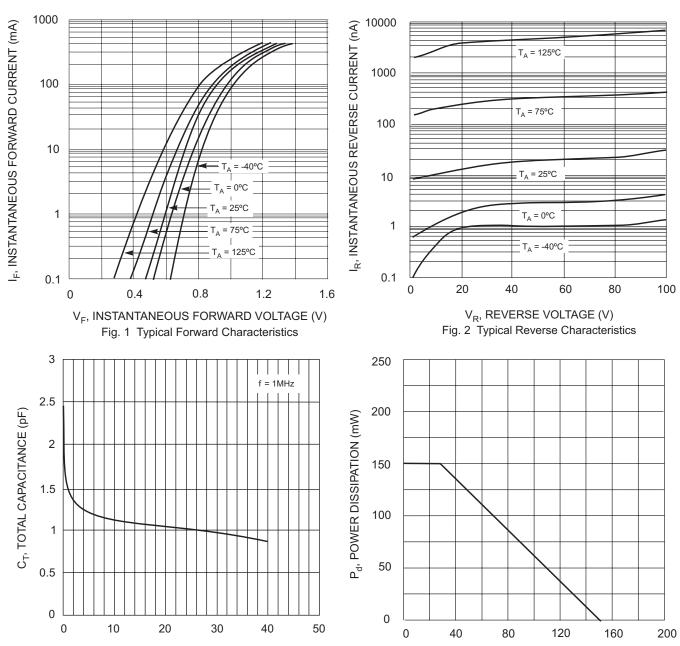
Characteristic	Symbol	Value	Unit	
Non-Repetitive Peak Reverse Voltage	V _{RM}	100	V	
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V _{RRM} V _{RWM} V _R	80	V	
RMS Reverse Voltage	V _{R(RMS)}	57	V	
Forward Continuous Current (Note 1)	I _{FM}	500	mA	
Average Rectified Output Current (Note 1)	Io	250	mA	
Non-Repetitive Peak Forward Surge Current @ t = 1.0µs @ t = 1.0s	I _{FSM}	4.0 2.0	А	
Power Dissipation (Note 1)	Pd	150	mW	
Thermal Resistance Junction to Ambient (Note 1)	$R_{ hetaJA}$	833	°C/W	
Operating and Storage Temperature Range	T _j , T _{STG}	-65 to +150	°C	

Electrical Characteristics @ TA = 25°C unless otherwise specified

Characteristic	Symbol	Min	Max	Unit	Test Condition		
Reverse Breakdown Voltage (Note 2)	V _{(BR)R}	80	_	V	I _R = 2.5μA		
Forward Voltage	V _F	0.62 — — —	0.72 0.855 1.0 1.25	V	I _F = 5.0mA I _F = 10mA I _F = 100mA I _F = 150mA		
Leakage Current (Note 2)	I _R	_	100 50 30 25	nA μA μA nA	$V_R = 70V$ $V_R = 75V$, $T_j = 150^{\circ}C$ $V_R = 25V$, $T_j = 150^{\circ}C$ $V_R = 20V$		
Total Capacitance	Ст	_	3.5	pF	V _R = 6V, f = 1.0MHz		
Reverse Recovery Time	t _{rr}	_	4.0	ns	$V_R = 6V$, $I_F = 5mA$		

- Notes: 1. Device mounted on FR-4 PC board with recommended pad layout, which can be found on our website at http://www.diodes.com/datasheets/ap02001.pdf.
 - 2. Short duration test pulse used to minimize self-heating effect.
- 3. No purposefully added lead DS30263 Rev. 9 2





 T_A , AMBIENT TEMPERATURE (°C) Fig. 4 Power Derating Curve, Total Package



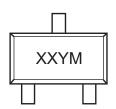
Ordering Information (Note 4)

Device	Packaging	Shipping
MMBD4448HT-7-F	SOT-523	3000/Tape & Reel
MMBD4448HTA-7-F	SOT-523	3000/Tape & Reel
MMBD4448HTC-7-F	SOT-523	3000/Tape & Reel
MMBD4448HTS-7-F	SOT-523	3000/Tape & Reel

Notes:

4. For Packaging Details: go to our website at http://www.diodes.com/datasheets/ap02007.pdf.

Marking Information



XX = Product Type Marking Code (See Page 1 Diagrams)

YM = Date Code Marking Y = Year (ex: N = 2002)

M = Month (ex: 9 = September)

Date Code Key

Year	2001	2002	2003	2004	2005	2006	2007	2008	2009	2010	2011	2012
Code	М	N	Р	R	S	Т	U	V	W	Х	Υ	Z
Month	Jan	Feb	March	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	4	0	_	4	F	6	7	0	0	_	N	D

IMPORTANT NOTICE

Diodes Incorporated and its subsidiaries reserve the right to make modifications, enhancements, improvements, corrections or other changes without further notice to any product herein. Diodes Incorporated does not assume any liability arising out of the application or use of any product described herein; neither does it convey any license under its patent rights, nor the rights of others. The user of products in such applications shall assume all risks of such use and will agree to hold Diodes Incorporated and all the companies whose products are represented on our website, harmless against all damages.

LIFE SUPPORT

Diodes Incorporated products are not authorized for use as critical components in life support devices or systems without the expressed written approval of the President of Diodes Incorporated.